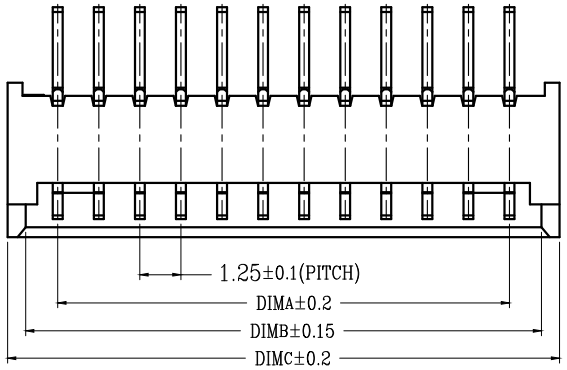
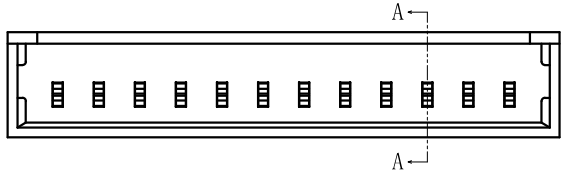
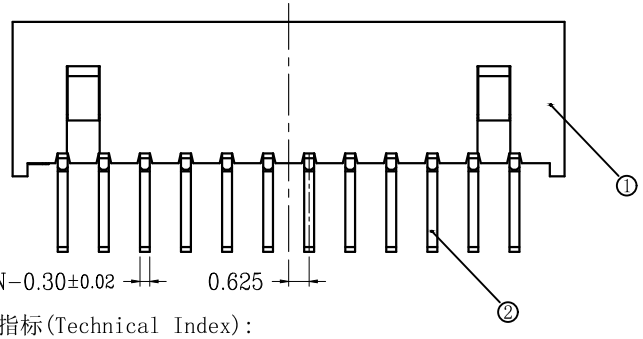
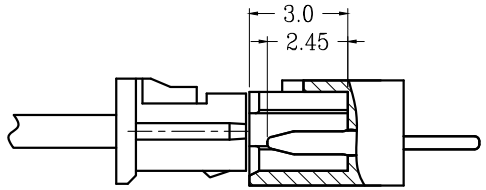
版次	变更摘要	日期
0	新产品发行	2018/01/18

序号	品名	材质
①	A型立式DIP型WTB胶芯 1.25 Pitch S/T Wire To Board Housing DIP(H=4.7)	PA66 UL94V-0 本色(常规用料) Natural(PA66 Conventional materials) LCP UL94V-0 本色Natural
②	A型立式DIP型WTB端子 1.25 Pitch S/T Wire To Board Terminal DIP(H=4.7)	铜合金/表面镀锡 Copper Alloy/ Tin Plating

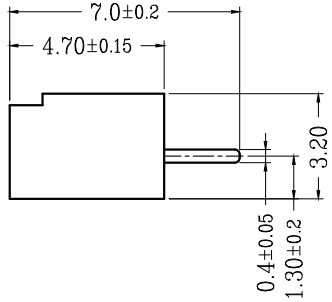


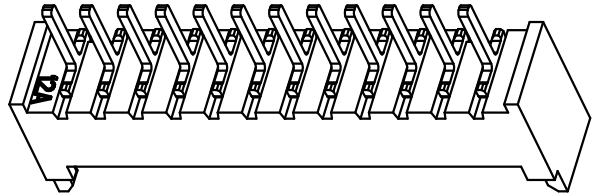






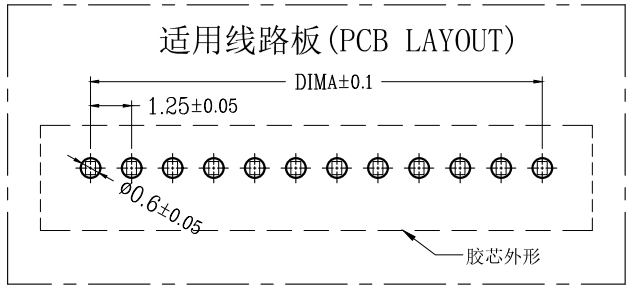
SECTION A-A





CKT	DIM A	DIM B	DIM C
2	1.25	3.20	4.30
3	2.50	4.45	5.55
4	3.75	5.70	6.80
5	5.00	6.95	8.05
6	6.25	8.20	9.30
7	7.50	9.45	10.55
8	8.75	10.70	11.80
9	10.00	11.95	13.05
10	11.25	13.20	14.30
11	12.50	14.45	15.55
12	13.75	15.70	16.80
13	15.00	16.95	18.05
14	16.25	18.20	19.30
15	17.50	19.45	20.55
16	18.75	20.70	21.80
17	20.00	21.95	23.05
18	21.25	23.20	24.30
19	22.50	24.45	25.55
20	23.75	25.70	26.80

适用线路板(PCB LAYOUT)



技术指标(Technical Index):

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象.(The surface of the plastic parts should be smooth, no rough edges, no obvious shrinkage, defects, cracks and other phenomena)
2. 锁扣窗口：2～3PIN为1个，≥4PIN为2个.
(Lock Configuration: 2 to 3Pin is 1, ≥4Pin is 2)
3. 温度范围(Temperature range)：-25° C～+85° C.
4. 额定电压(Rated voltage)：125V，AC/DC(=等效).
5. 接触电阻(Contact resistance)：≤0.02Ω.
6. 绝缘电阻(Insulation resistance):≥100MΩ
7. 产品料号(Product material No.)：

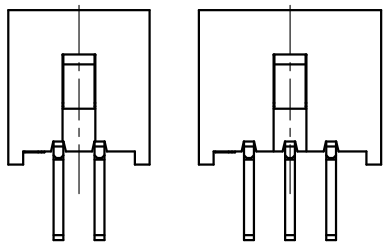
WT125AL—** * *—**

D2	DIP型,成品LCP 料无LOGO:WD
DP	DIP型,成品高温 料无LOGO:WD
D9	DIP型,成品普通 料无LOGO:WD

NO OF CKT(产品PIN数)

Plating(电镀方式)
0:端子全雾锡(Terminal all mist tin)
4:端子全亮锡(Terminal all bright tin)

Packing(包装方式)
P:PE袋装/盒装(Bag package)



2 PIN　　3 PIN

LOCK CONFIGURATION (锁扣位置)

RoHS

一般公差(TOLERANCE)
X. ±.50　.XX ±.10
.X ±.20　.XXX ±.05
ANGLES ±1°

ZGWD 浙江温达电子有限公司
ZHEJIANG WENDA ELECTRONICS CO.,LTD

品名 (TITLE) 1.25 Pitch A型直针WTB 1.25 PITCH H4.7 S/T WIRE TO BOARD DIP CONN.		制图 (DR) ANLAN	
料号 (DWG.NO) WT125AL-****-**		校对 (CHKD) 李绍宗	
		审核 (APPD) 黄志明	
比例 (SCALE) 1:1	单位 (UNITS) mm	张数 (SHEET) 1 OF 1	SIZE A4 / REV A